

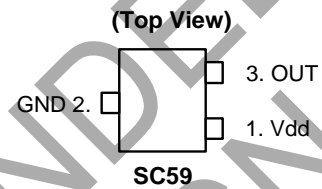
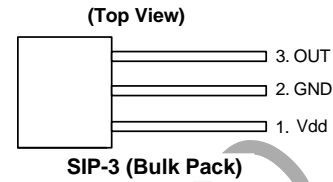
Description

AH337 is a unipolar Hall-Effect sensor for contactless switching applications. The device includes an on-chip Hall voltage generator for magnetic sensing, an amplifier that amplifies the Hall voltage, a Schmitt trigger to provide switching hysteresis for noise rejection, and an open-collector output. The band-gap regulator allows a wide operating voltage range.

When the magnetic flux density (**B**) is larger than operate point (**Bop**), output is switched on (OUT pin is pulled low). The output state is held on until a magnetic flux density falls below Brp. When **B** is less than Brp, the output is switched off.

The AH337 is available in SIP-3 (Ammo Pack), SIP-3 (Bulk Pack) and SC59 packages.

Pin Assignments



Features

- Unipolar Hall-Effect Sensor
- 4.2V to 28V DC Operating Voltage
- Temperature Compensation
- Open Drain Pre-Driver
- 25mA Maximum Output Sink Current
- Operating Temperature: -40°C to +125°C
- SIP-3 (Ammo Pack), SIP-3 (Bulk Pack) and SC59 Packages (SC59 Is Commonly Known as SOT23 in Asia)
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

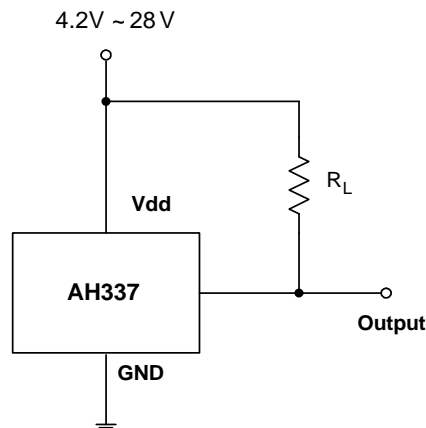
Applications

- VCD/DVD Loader, CD/DVD ROM
- Cover Detector
- Speed Measurement
- Home Appliances
- Home Safety

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

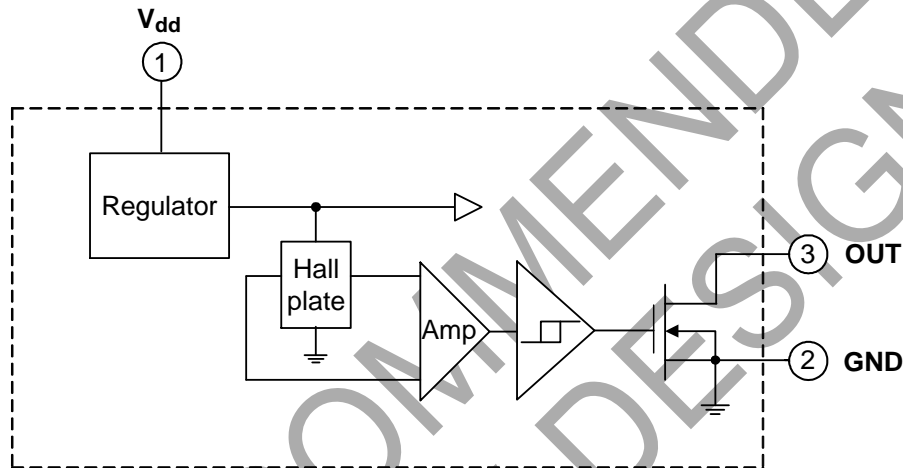
Typical Applications Circuit



Pin Descriptions

Pin Name	P/I/O	Pin #	Description
Vdd	P	1	Positive Power Supply
GND	P	2	Ground
OUT	O	3	Output Pin

Functional Block Diagram



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Symbol	Characteristics		Values	Unit
V _{dd}	Supply Voltage		30	V
B	Magnetic Flux Density		Unlimited	
V _{DS}	Output OFF Voltage		30	V
I _d	Output "ON" Current	Continuous	25	mA
T _S	Storage Temperature Range		-65 to +150	°C
T _{J(MAX)}	Maximum Junction Temperature		+150	°C
P _D	Package Power Dissipation			
	SIP-3 (Ammo Pack)		550	mW
	SIP-3 (Bulk Pack)		550	mW
	SC59		230	mW

Recommended Operating Conditions (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V _{dd}	Supply Voltage (Note 4)	Operating	4.2	28	V
T _A	Operating Ambient Temperature	Operating	-40	+125	°C

Notes: 4. The output of IC will be switched after the supply voltage is over 4.2V, but the magnetic characteristics won't be normal until the supply is over 4.5V.

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, $V_{dd} = 12\text{V}$, unless otherwise specified.)

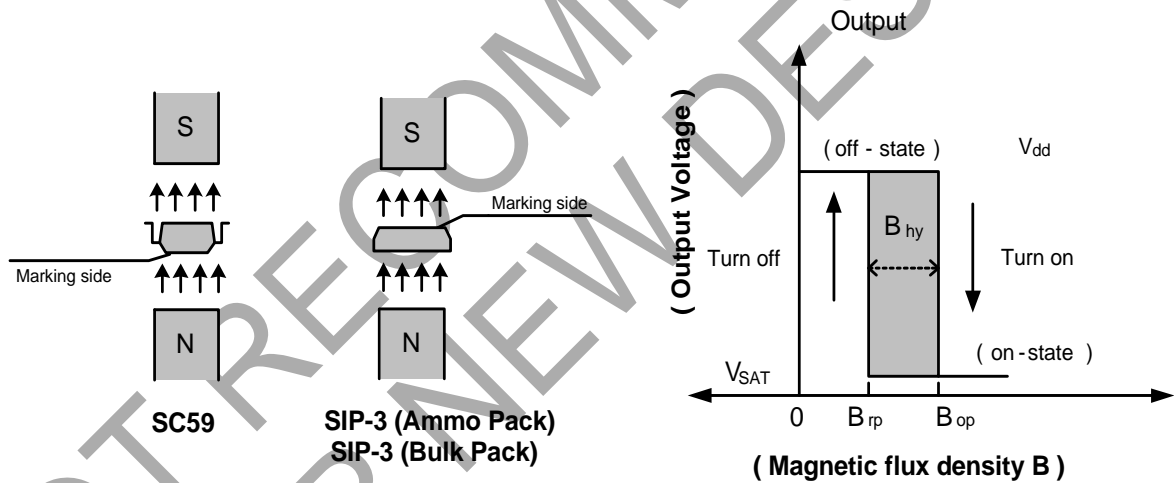
Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$V_{DS(SAT)}$	Output Saturation Voltage	$I_{OUT} = 10\text{mA}$, $B > B_{op}$	-	300	400	mV
I_{off}	Output Leakage Current	$B < B_{rp}$	-	< 0.1	10	μA
I_{dd}	Supply Current	Output Open	-	2	4	mA

Magnetic Characteristics ($T_A = +25^\circ\text{C}$, $V_{dd} = 4.5\text{V}$ to 28V , Note 5)

Symbol	Parameter	Min	Typ	Max	Unit
Bops (South Pole to Brand Side)	Operation Point	90	120	150	Gauss
Brps (South Pole to Brand Side)	Release Point	30	60	90	Gauss
Bhy ($ B_{opx} - B_{rpx} $)	Hysteresis	-	60	-	Gauss

Notes: 5. Magnetic characteristics may vary with supply voltage, operating temperature and after soldering.

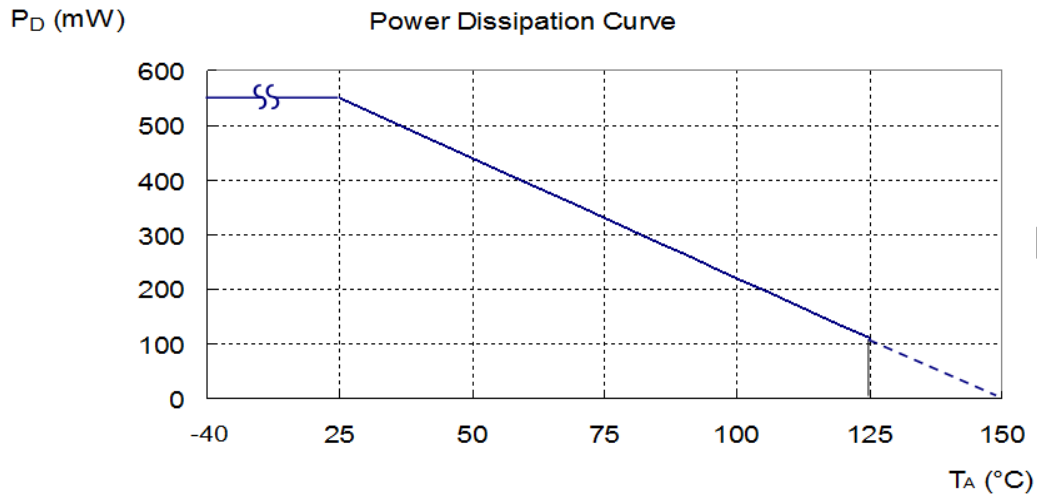
Performance Characteristics



Performance Characteristics

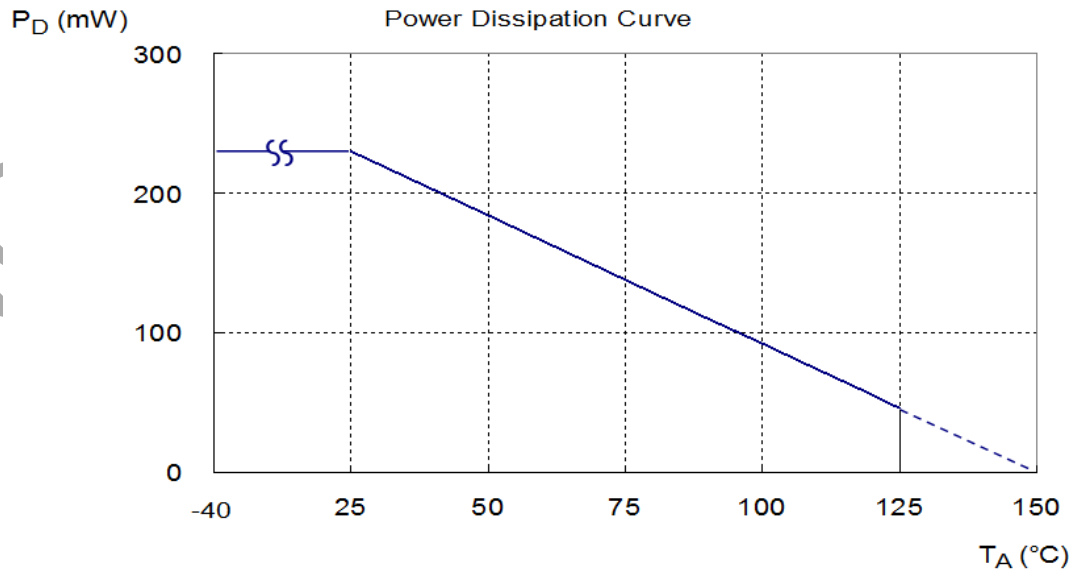
(1) SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)

T_A (°C)	25	50	60	70	80	85	90	95	100
P_D (mW)	550	440	396	352	308	286	264	242	220
T_A (°C)	105	110	115	120	125	130	135	140	150
P_D (mW)	198	176	154	132	110	88	66	44	0

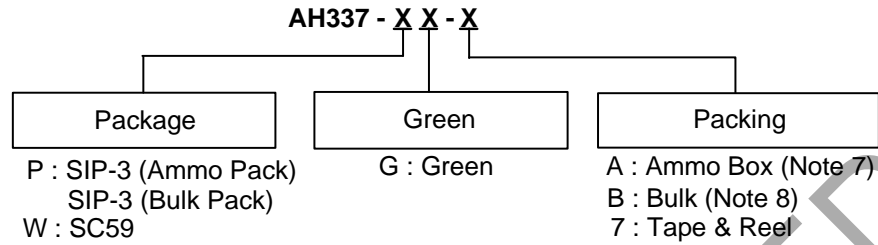


(2) SC59 (Commonly Known as SOT23 in Asia)

T_A (°C)	25	50	60	70	80	85	90	100	110	120	130	140	150
P_D (mW)	230	184	166	147	129	120	110	92	74	55	37	18	0



Ordering Information



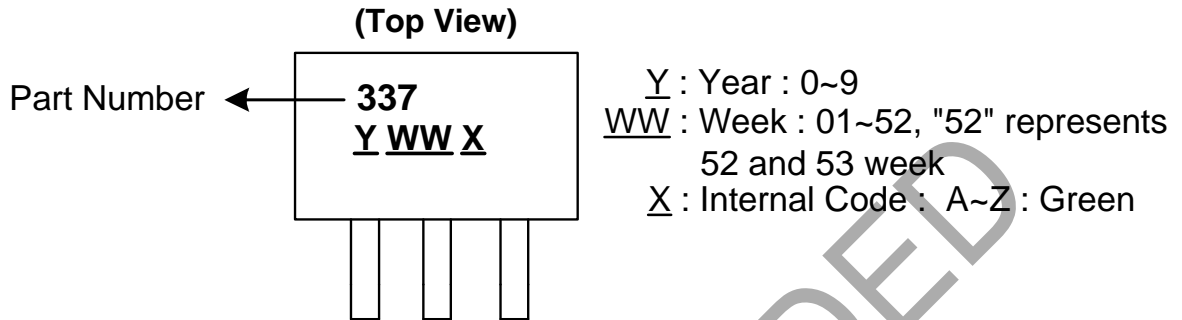
Part Number	Status (Note 9)	Package Code	Packaging (Note 6)	Bulk		7" Tape and Reel		Ammo Box	
				Quantity	Part Number Suffix	Quantity	Part Number Suffix	Quantity	Part Number Suffix
AH337-PG-A	NRND	P	SIP-3 (Ammo Pack)	NA	NA	NA	NA	4000/Box	-A
AH337-PG-B	NRND	P	SIP-3 (Bulk Pack)	1000	-B	NA	NA	NA	NA
AH337-WG-7	NRND	W	SC59	NA	NA	3000/Tape & Reel	-7	NA	NA

- Notes:
- 6. Pad layout as shown on Diodes Incorporated's suggested pad layout document, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
 - 7. Ammo Box is for SIP-3 Spread Lead.
 - 8. Bulk is for SIP-3 Straight Lead.
 - 9: NRND = Not Recommended for New Design

NOT RECOMMENDED FOR NEW DESIGN

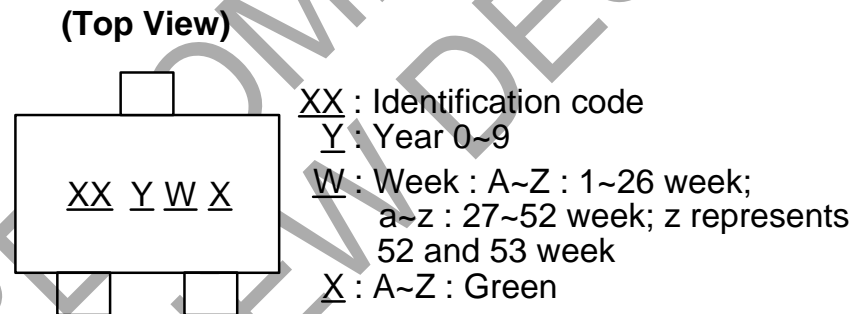
Marking Information

(1) Package Type: SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)



Part Number	Package	Identification Code
AH337	SIP-3 (Ammo Pack)	337
AH337	SIP-3 (Bulk Pack)	337

(2) Package Type: SC59

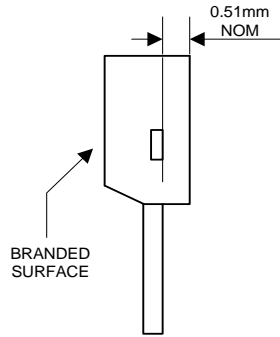


Part Number	Package	Identification Code
AH337	SC59	P1

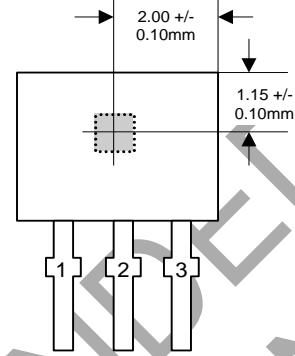
Package Outline Dimensions (All Dimensions in mm)

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(1) Package Type: SIP-3 (Bulk Pack)

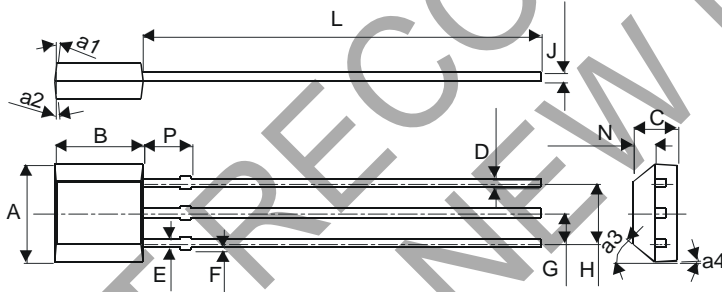


Active Area Depth



Sensor Location

Package Dimensions

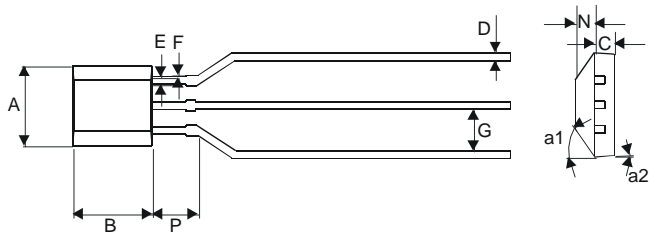


SIP-3 (Bulk Pack)		
Dim	Min	Max
A	3.9	4.3
a1	5° Typ	
a2	5° Typ	
a3	45° Typ	
a4	3° Typ	
B	2.8	3.2
C	1.40	1.60
D	0.33	0.432
E	0.40	0.508
F	0	0.2
G	1.24	1.30
H	2.51	2.57
J	0.35	0.43
L	14.0	15.0
N	0.63	0.84
P	1.55	-
All Dimensions in mm		

Package Outline Dimensions (Continued)

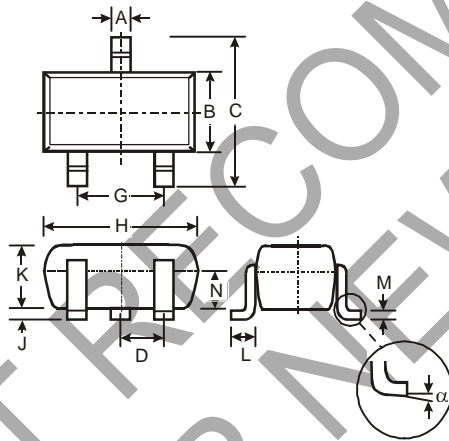
Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(2) Package Type: SIP-3 (Ammo Pack)

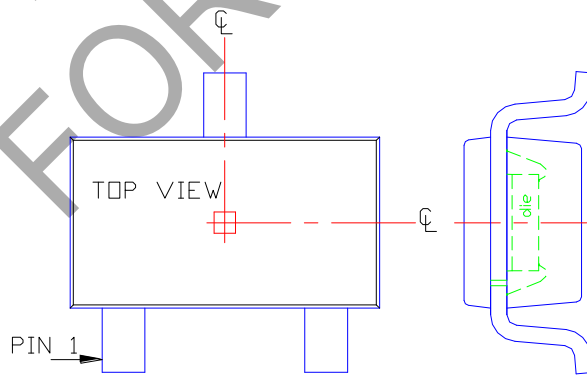


SIP-3 (Ammo Pack)		
Dim	Min	Max
A	3.9	4.3
a1	45° Typ	
a2	3° Typ	
B	2.8	3.2
C	1.40	1.60
D	0.35	0.41
E	0.43	0.48
F	0	0.2
G	2.4	2.9
N	0.63	0.84
P	1.55	-
All Dimensions in mm		

(3) Package Type: SC59 (Commonly Known as SOT23 in Asia)



SC59			
Dim	Min	Max	Typ
A	0.35	0.50	0.38
B	1.50	1.70	1.60
C	2.70	3.00	2.80
D	-	-	0.95
G	-	-	1.90
H	2.90	3.10	3.00
J	0.013	0.10	0.05
K	1.00	1.30	1.10
L	0.35	0.55	0.40
M	0.10	0.20	0.15
N	0.70	0.80	0.75
α	0°	8°	-
All Dimensions in mm			

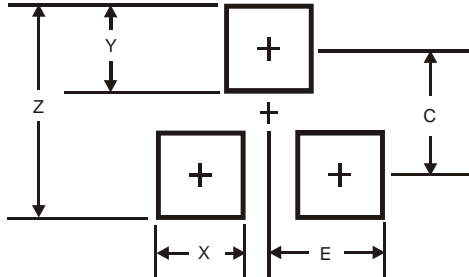


CL = Package Center Line

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

(1) Package Type: SC59 (Commonly Known as SOT23 in Asia)



Dimensions	Value (in mm)
Z	3.4
X	0.8
Y	1.0
C	2.4
E	1.35

IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or
2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2018, Diodes Incorporated

www.diodes.com

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9